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Form PTO-1595 (Rev 09/	PTO-1595 (Rev 09/ 04) 03/03/2011 0 0851-0027 (exp 8/30/2005) RECC 03/16/2011		3/03/2011	U.S. DEPARTMENT OF COMMERCE				
OMB No 0851-0027 (exp			16/2011	Inited State	es Patent an	d Traden	nark Office	
To the Director of the U.S. Patent and Trade			nts or the new address(es) below			below		
1. Name of conveying party(ies)/Execu. 103			520081 receiving party(les)					
SHINGO UTSU	KI							
			Name	SONY CORE	ORATI	ON		
Execution Date(s) February 21, 2011			Street Address					
Additional name(s) of conveying party(les) attached? Yes X No								
		1-7-1 Konan, Minato-ku						
3. Nature of Convey	[ <del>]</del>	Tokyo 108-0075 JAPAN						
X Assignment Merger			JAPAN					
Security Agreement Change of Name			City					
Government Interest Assignment			State <sup>-</sup>					
Executive Order 9424, Confirmatory License			Country Zip					
Other			Additional name(s)	& address(es)	Yes	U	No	
			attached			×	No	
		abers attached?		K No				
5. Name and address to whom correspondence concerning document should be mailed:			6. Total number of patents involved		a [	1		
Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP			7. Total fee (37 CF	R 1.21(h) & 3 41)	\$	40.00	<u> </u>	
Internal Address Atty. Dkt . SONYJP 3 0-2447			Authorized to be charged by credit card					
Street Address: 600	South Avenue West		Enclosed	to be charged to			ng title)	
City	Westfield		8. Payment Inform					
State N		07090	a. Credit Card 3/1				<del>129</del> 3 <b>2</b> 748	
Phone Number (908) 518-6374			91 FC: Seppiration Date 46_98_94					
Fax Number:				b Deposit Account Number 12-1095 Authorized User Name Dennis M. Smid, Esq				
Email Address:	dsmid@ldlkm.co	<u>m</u>	Additionzed Ose				=	
9. Signature:	· M. U			M	arch 3, 2	2011		
	Signature	04.000	Tate	al number of pages	including o	cover	2	
	Dennis M. Smid, Esq - Name of Person Signin		she	et, attachments, an	d documer	nts	للـــُــ	
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PATENT REEL: 025964 FRAME: 0469

Attorney Docket No. SONYJP 3.0-2447 SONY Ref. No.: S11P0485US00

## **ASSIGNMENT**

WHEREAS. I. as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING APPARATUS, IMAGE PROCESSING METHOD, AND IMAGE PROCESSING PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address.

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in the spaces that follow: Serial Number:	this application to insert the serial number and filing date of this application in				
This assignment executed on the dates indicated below	, I ming Date.				
SHINGO UTSUKI					
Name of first or sole inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application				
Residence of First or sole inventor					
Skingo Utruki	Feb. 21, 2011				
Signature of first or sole inventor	Date of this assignment				
Name of second inventor	Execution date of U.S. Patent Application				
Residence of second inventor					
Signature of second inventor	Date of this assignment				
Name of third inventor	Execution date of U.S. Patent Application				
Residence of third inventor					
Signature of third inventor	Date of this assignment				

PATENT REEL: 025964 FRAME: 0470